



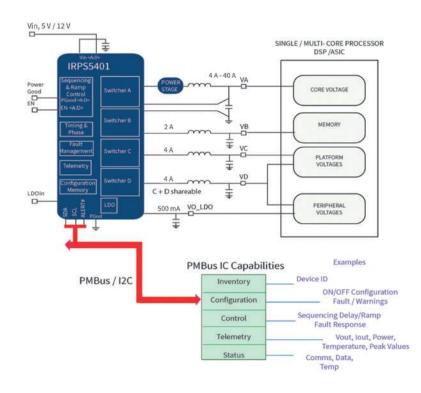
# **Product Brief**

# Multi-Output PMIC with Integrated Sequencer

IRPS5401

The IRPS5401 is an integrated power management IC ideal for tight board space requirements; for example, FPGAs, System On Chip ASICs and multi-core processors containing several voltages that require precision accuracy and voltage sequencing.

## **Typical Application**



#### **Industry reference Designs**

IRPS5401 is designed to support several industry ASICs, FPGA's and SOCs.

## Key features

- > Multi-output DC/DC with integrated FETs and Sequencer
- > 4 switchers and 1 LDO in one package
  - Output A: 2 A (without), 50 A (with power stage)
  - Output B: 2 A
  - Outputs C,D: 4 A
  - Linear regulator: +/-0.5 A
- > Full PMBus: Margining, Fault Management, Telemetry

## Key benefits

- Simplified BOM: Replace many regulators with one PMIC
- Design re-use: One design is scalable to cover wide range of FPGAs and ASICs
- > Lower total solution cost: Eliminates external sequencer
- 35% board area reduction: High level integration and component reduction

### **Target Applications**

- High density ASIC, FPGA & CPU multi-rail systems
- Xilinx Zynq ZU02 to ZU19 Embedded Computing systems
- Communications and Storage systems
- > Telecom
- > Video Processing
- > IoT
- > Instrumentation









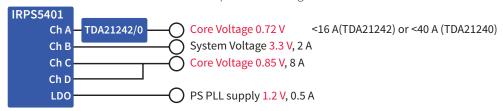
# Multi-Output PMIC with Integrated Sequencer

IRPS5401

### Scalable Power Options for Power Design Flexibility

IRPS5401's flexibility easily addresses different types of ASICs and FPGAs. With the addition of an external power stage shown in example 1, it can easily address high current requirements.

### Example PMIC Configuration 1



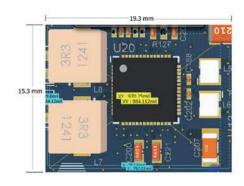
### Example PMIC Configuration 2



### **Compact Power Solutions Includes Sequencer**

Complete ASIC/FPGA power solution including sequencer in 295mm<sup>2</sup> represents a 35% reduction over traditional solutions.

	Part Number	Application	Status
	IRPS5401MTRPBF	Blank, unprogrammed part for general use	Active & Preferred
	IRPS5401MXI03TRP	Pre-programmed for Xilinx Zynq UltraScale+ ZU02 to ZU09	Coming Soon



Published by Infineon Technologies AG 81726 Munich, Germany

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